

# Multifunctional Thermoset Polymer Matrix with Self-Sensing and Self-Healing Capabilities

Bongsung Koo, Ryan Gunckel, Aditi Chattopadhyay, and Lenore Dai  
School for Engineering of Matter, Transport and Energy



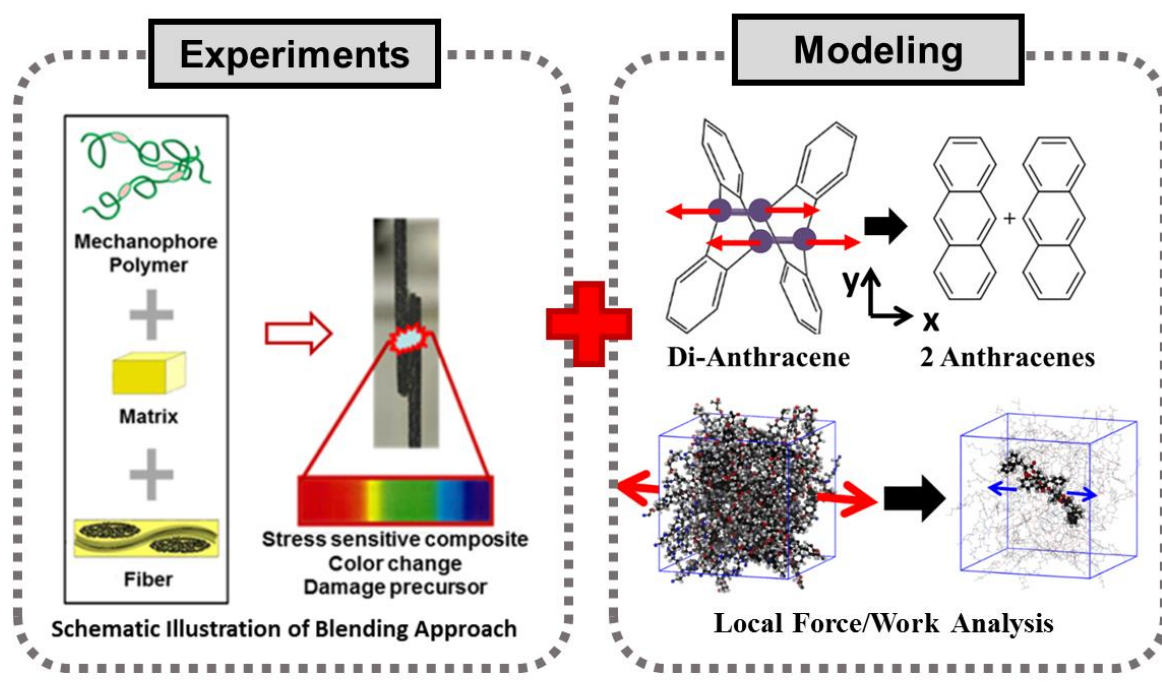
Research supported by Army Research Office (ARO)  
Technical Monitor: Dr. David Stepp and Dr. Julie Fife

## Objectives:

- Identification of damage precursors in polymer matrix composite structures
- Synthesis and characterization of mechanophore embedded thermoset polymer (self-sensing/self-healing)
- Development of a novel modeling framework to simulate mechanochemical reaction of mechanophores
- Validation of the modeling framework with experimentally observed responses

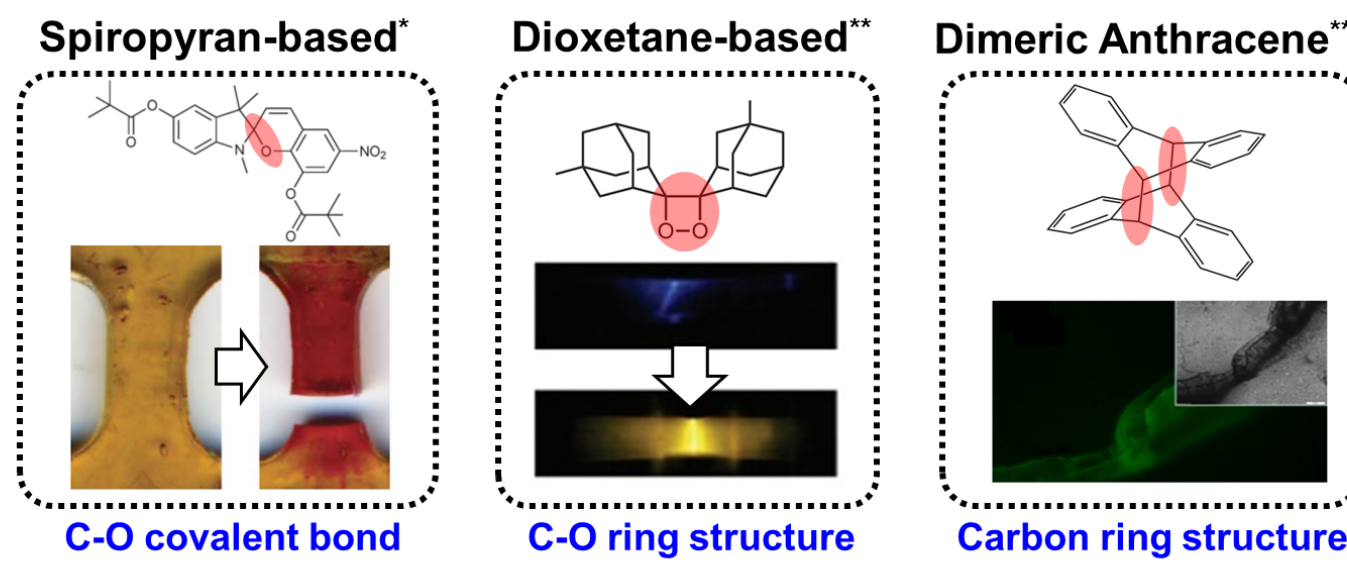
### Motivation for Research

Motivation: Urgent need for novel materials for damage precursor detection in polymer matrix composites



- Research Outcomes
- Mechanophoric polymers with damage detection capability
  - Simulation framework for mechanochemistry
  - Integration of experiments and simulations for materials by design

### Mechanophores

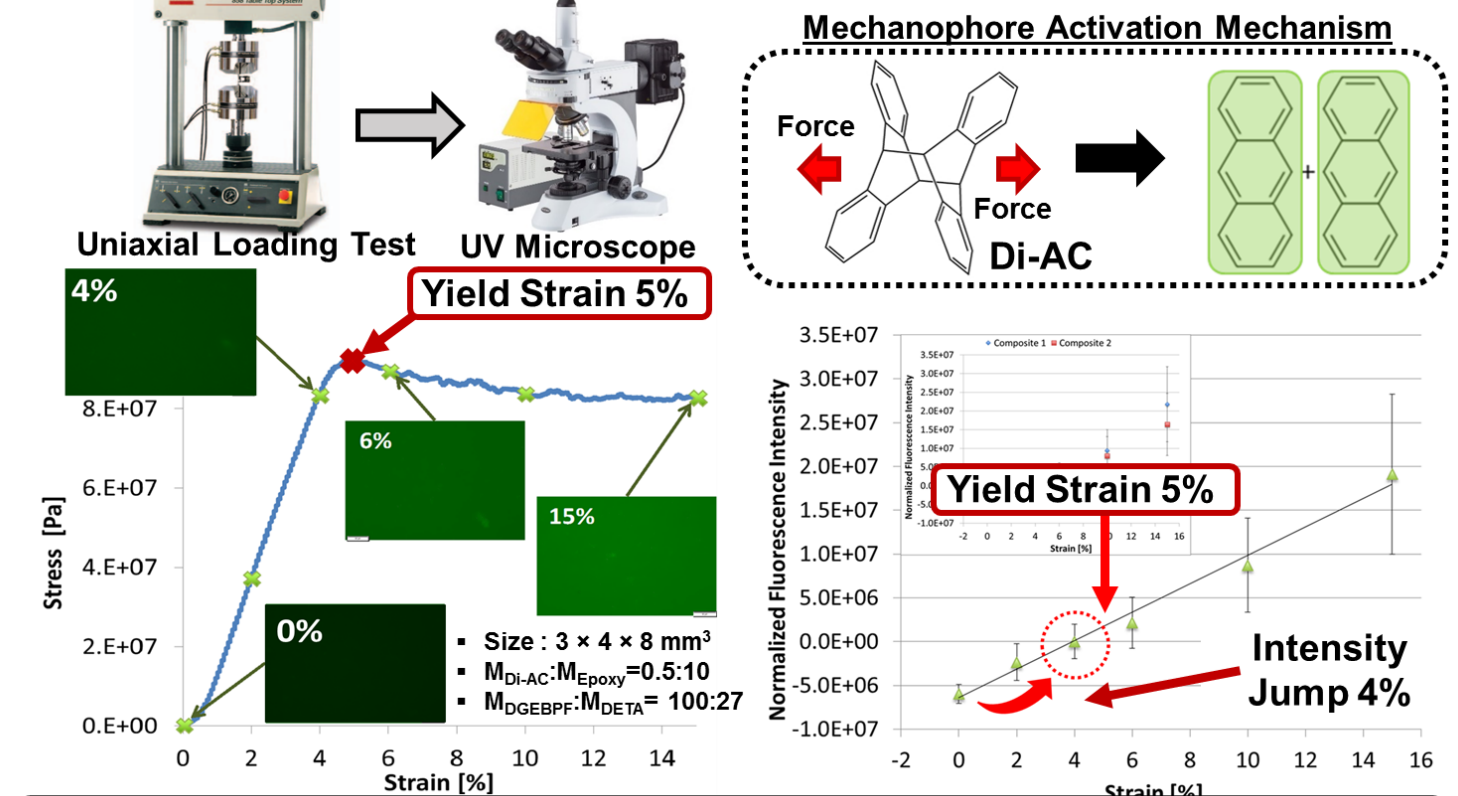


"A stress or strain activated molecular unit providing a molecular-scale reading of the local mechanical state or to transform materials properties in response to the local mechanical environment."

\*Davis et al. *Nature* (2009). \*\*Chen et al. *Nature chemistry* (2012)  
\*\*\*Nofen et al. *Mat. Res. Exp.* (2016)

Dimeric-Anthracene (Di-AC) mechanophore used in thermosets for aerospace applications

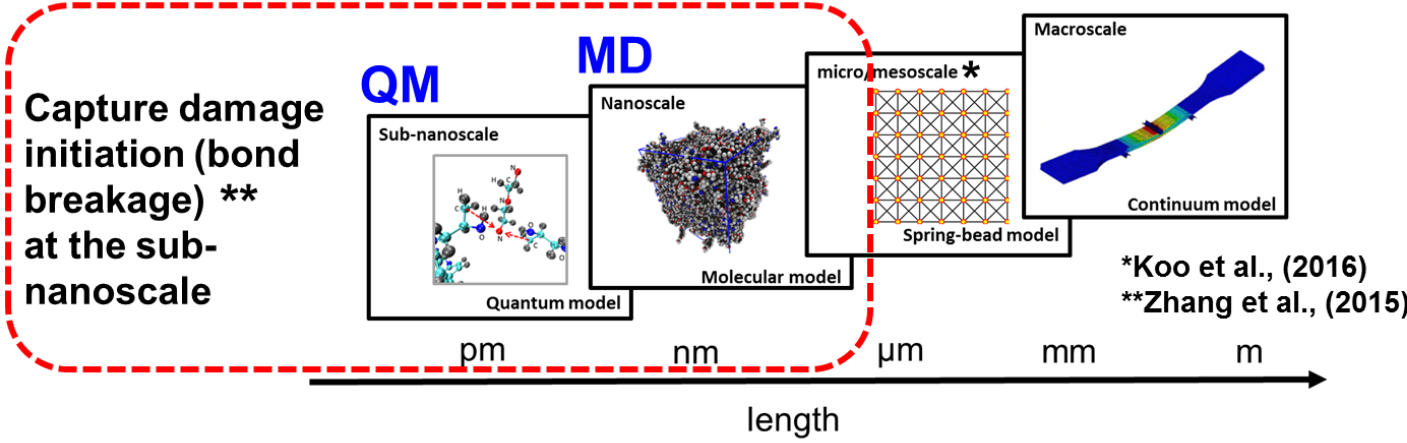
### Employment of Dimeric Anthracene (Di-AC)-based Mechanophore Polymers\*



Di-AC nanocomposite successfully shows early signal detection capability

### Modeling of Di-AC based Mechanophore Thermoset Polymers

- Develop a new method to generate epoxy network (epoxy curing) and simulate mechanophore activation (covalent bond breakage)
- Physics-based modeling approach provides information to mechanophore design enhancement



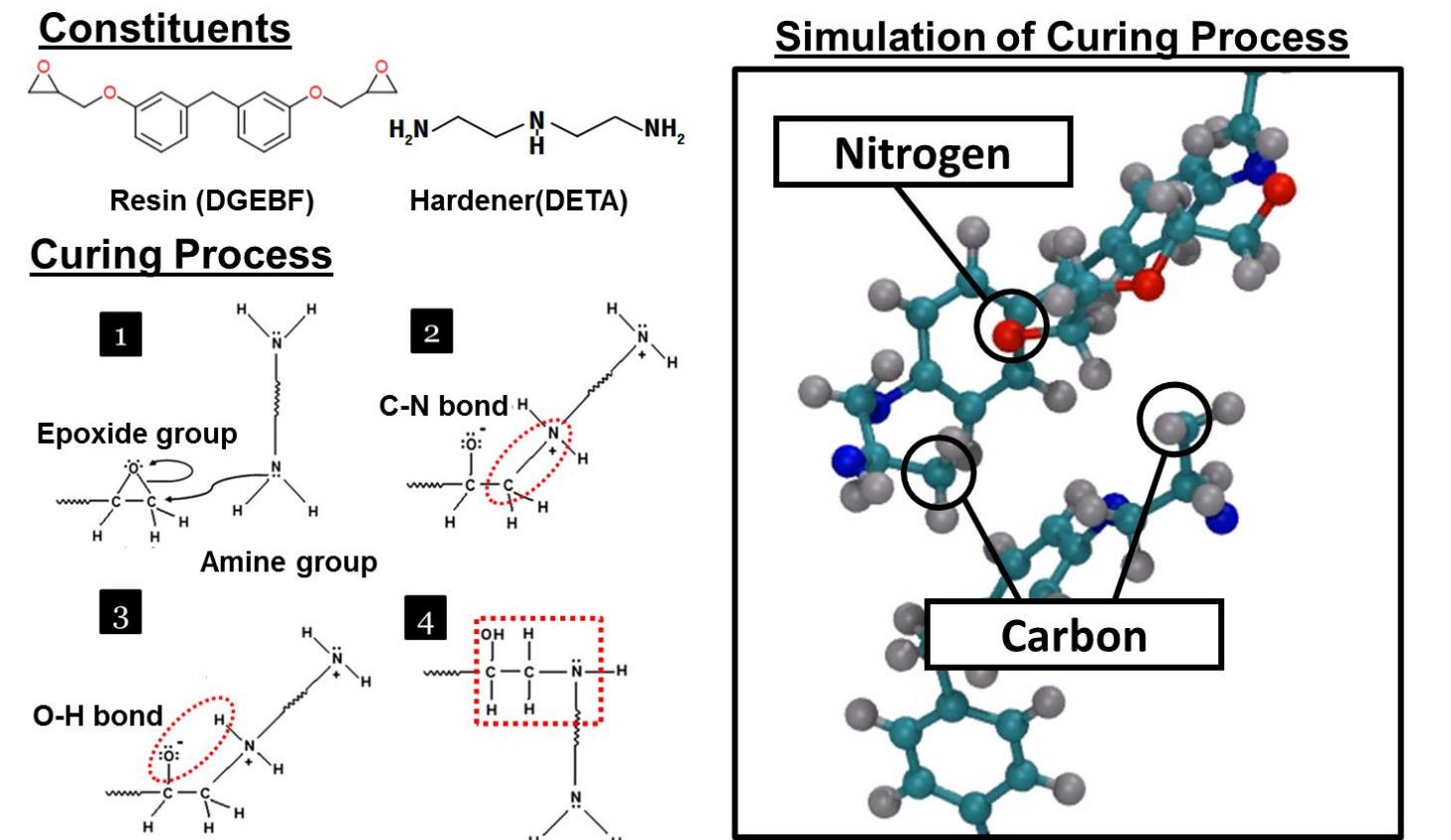
Quantum Mechanics + Molecular Dynamics => Hybrid MD Simulation Framework

### Hybrid MD Simulation Framework

#### Key elements

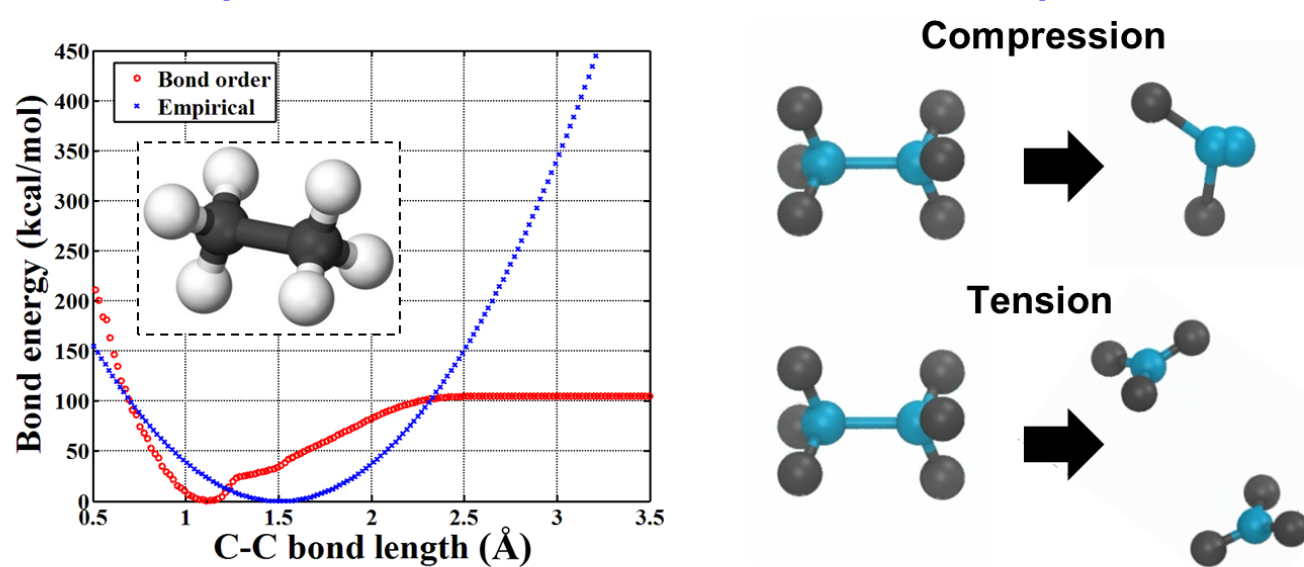
- Epoxy network
  - Perform covalent bond generation method
- Covalent bond dissociation
  - Implement bond-order based force field
- Mechanical loading test in MD
  - Develop a quasi-continuum deformation method
- Characterization of Di-AC (mechanophore)
  - Calculate bond dissociation energy

### Epoxy Curing Simulation



Epoxy-based thermoset matrix (host) generated

### Covalent Bond Dissociation (Bond-order based force field)

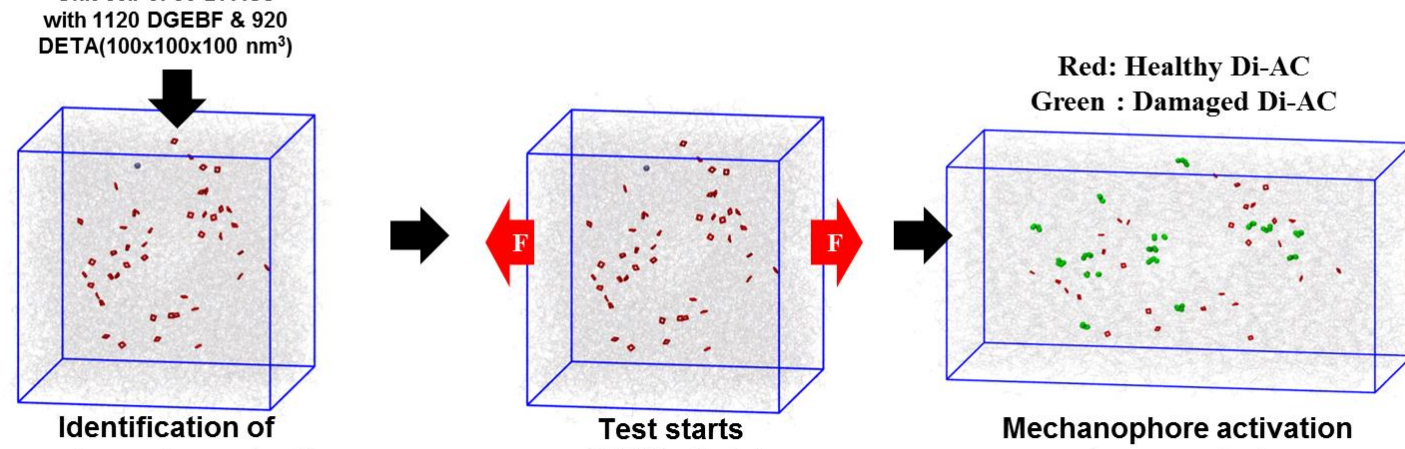


- Empirical (traditional) bond potential in MD does not simulate bond dissociation
- $\sigma$ -bond,  $\pi$ -bond, and  $\sigma$ - $\pi$ -bond must be captured

Need bond-order based force-field => Reactive Force Field (ReaxFF)

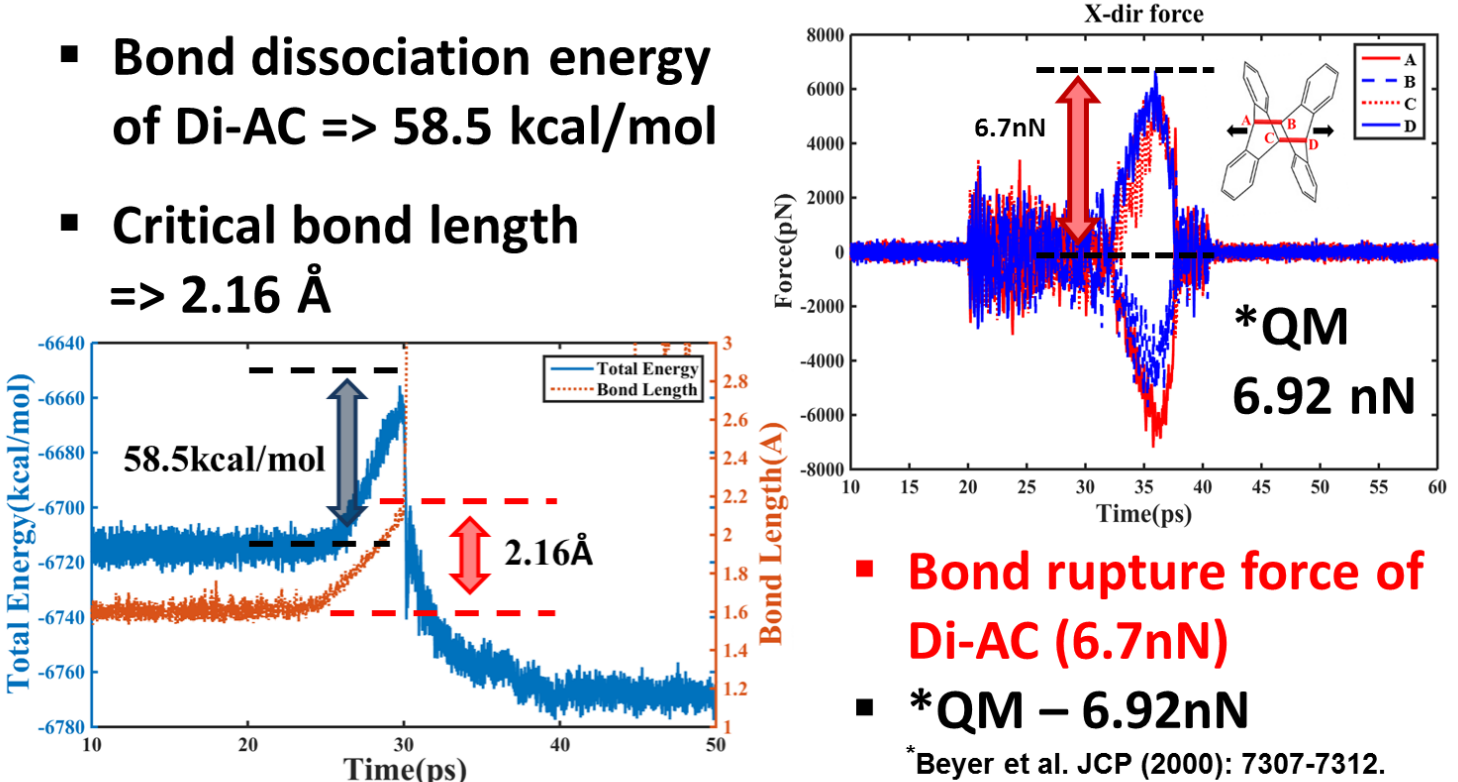
### Mechanophore Activation using Virtual Loading Test

- Virtual loading test with ReaxFF capture damage initiation and plastic deformation
- During virtual loading test, covalent bonds of Di-AC break and Di-AC (red) changes to anthracene groups (green)



Covalent bond dissociation successfully simulated

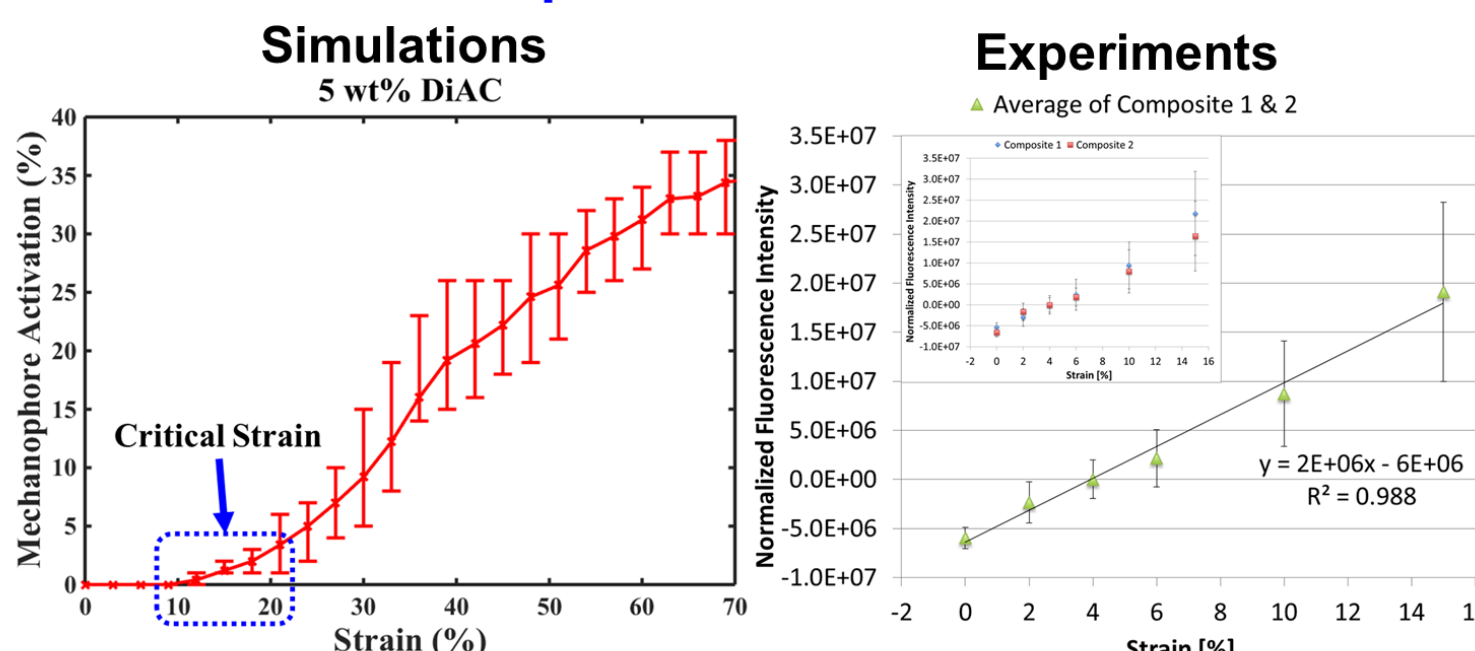
### Characterization of Di-AC



- Bond dissociation energy of Di-AC => 58.5 kcal/mol
- Critical bond length => 2.16 Å
- Bond rupture force of Di-AC (6.7 nN)
- \*QM - 6.92 nN

Thresholds

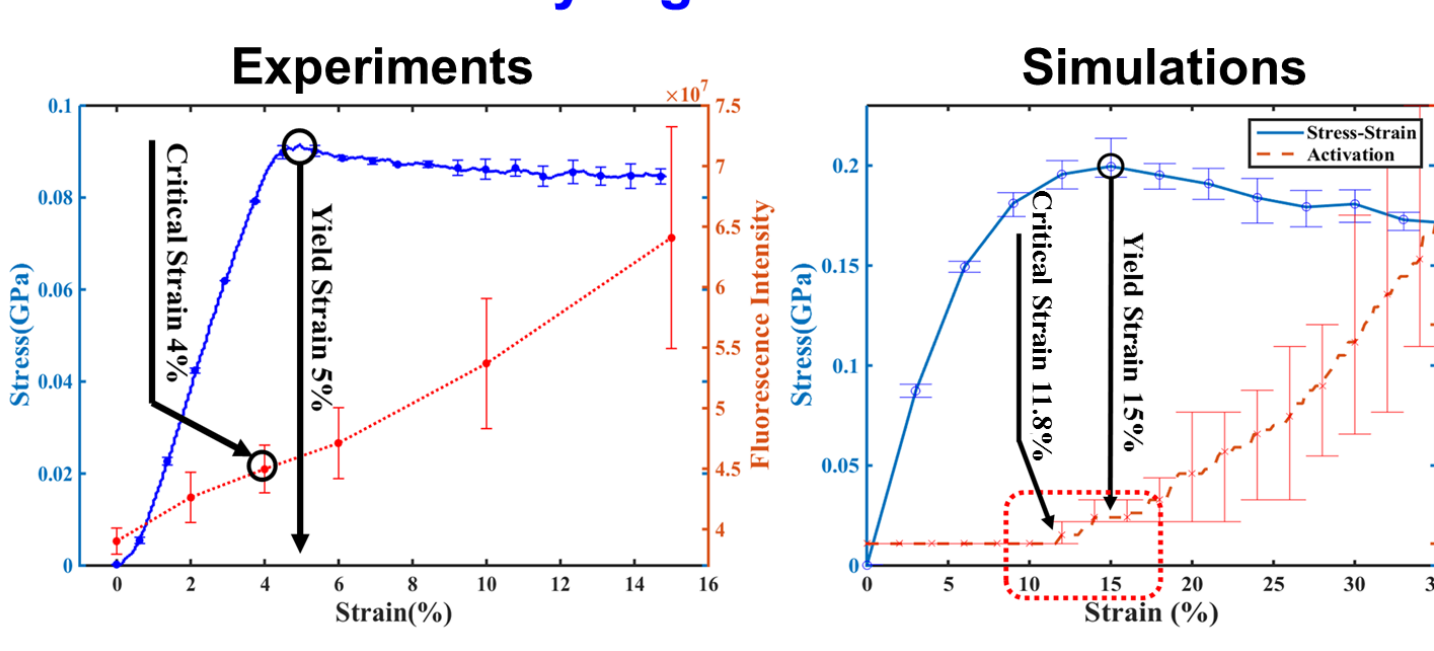
### Mechanophore Activation Curve



- Proportional increase in intensity as specimen deforms; good correlation between modeling and experiments
- Critical strain values representing the onset of mechanophore activation are estimated

Mechanophore activation can represent intensity curve

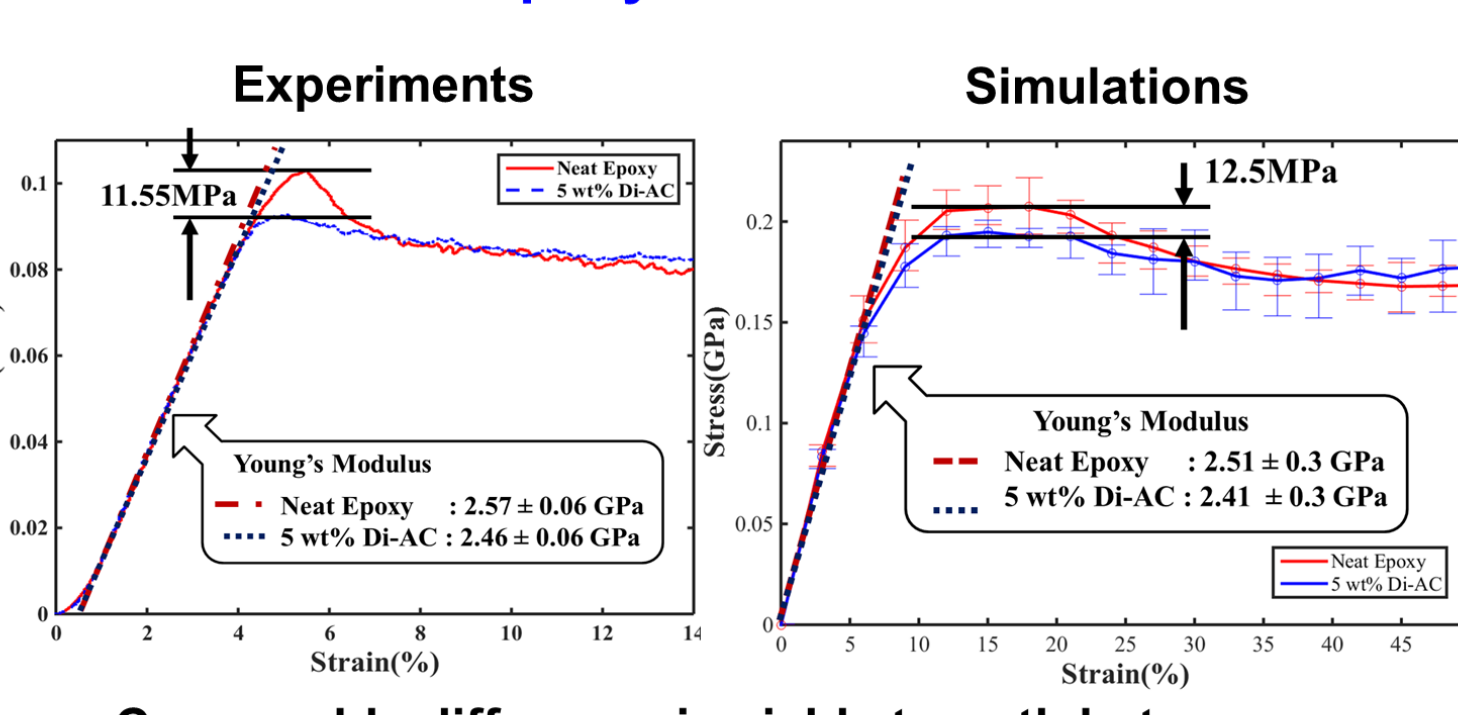
### Early Signal Detection



- Early signal detection of Di-AC was observed in experiments

Early signal detection is captured computationally through the comparison of stress-strain curve and mechanophore activation

### Yield Strength Comparison Neat Epoxy vs. 5 wt% Di-AC



- Comparable difference in yield strength between simulations and experiments

Captures experimentally observed responses